MOSFET – Power, Dual N-Channel, Logic Level, Dual SO8FL 60 V, 33 mΩ, 22 A

NTMFD5875NL

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

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Parameter			Symbol	Value	Unit		
Drain-to-Source Voltage			V _{DSS}	60	V		
Gate-to-Source Voltage			V _{GS}	±20	V		
$\begin{array}{c} \mbox{Continuous Drain Current } R_{\theta JC} \ (\mbox{Notes 1, 2, } \\ 3, 4) \end{array}$		T _C = 25°C	I _D	22	А		
	Steady	T _C = 100°C		15			
Power Dissipation $R_{\theta JC}$ (Notes 1, 2, 3)	State	T _C = 25°C	PD	32	W		
		$T_{C} = 100^{\circ}C$		16			
$\begin{array}{c} \mbox{Continuous Drain Current $R_{\theta JA}$ (Notes 1 \& 3, 4) \\ \hline \mbox{Power Dissipation} $R_{\theta JA}$ (Notes 1, 3) \\ \end{array}$		T _A = 25°C	I _D	7	А		
	Steady State	T _A = 100°C		5.8			
		$T_A = 25^{\circ}C$	PD	3.2	W		
		T _A = 100°C		2.2			
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	80	А		
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to +175	°C		
Source Current (Body Diode)			I _S	19	А		
$ \begin{array}{l} \mbox{Single Pulse Drain-to-Source Avalanche} \\ \mbox{Energy } (T_J = 25^\circ C, \\ \mbox{V}_{DD} = 24 \mbox{ V}, \mbox{V}_{GS} = \\ \mbox{10 V}, \mbox{R}_G = 25 \Omega) \end{array} $	(I _{L(pk)} = 14.5 A, L = 0.1 mH)		E _{AS}	10.5	mJ		
	(I _{L(pk)} = 6.3 A, L = 2 mH)			40			
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C			

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 2, 3)	$R_{\theta JC}$	4.65	°C/W
Junction-to-Ambient - Steady State (Note 3)	R _{0.IA}	47	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Psi (Ψ) is used as required per JESD51-12 for packages in which substantially less than 100% of the heat flows to single case surface.

3. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

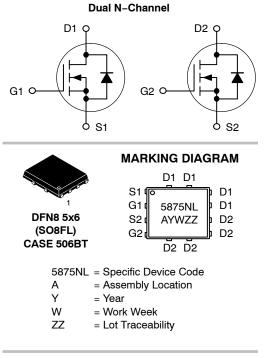
4. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
60 V	33 mΩ @ 10 V	22 A
00 V	45 mΩ @ 4.5 V	22 A



ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFD5875NLT1G	DFN8 (Pb-Free)	1500 / Tape & Reel
NTMFD5875NLT3G	DFN8 (Pb-Free)	5000 / Tape & Reel

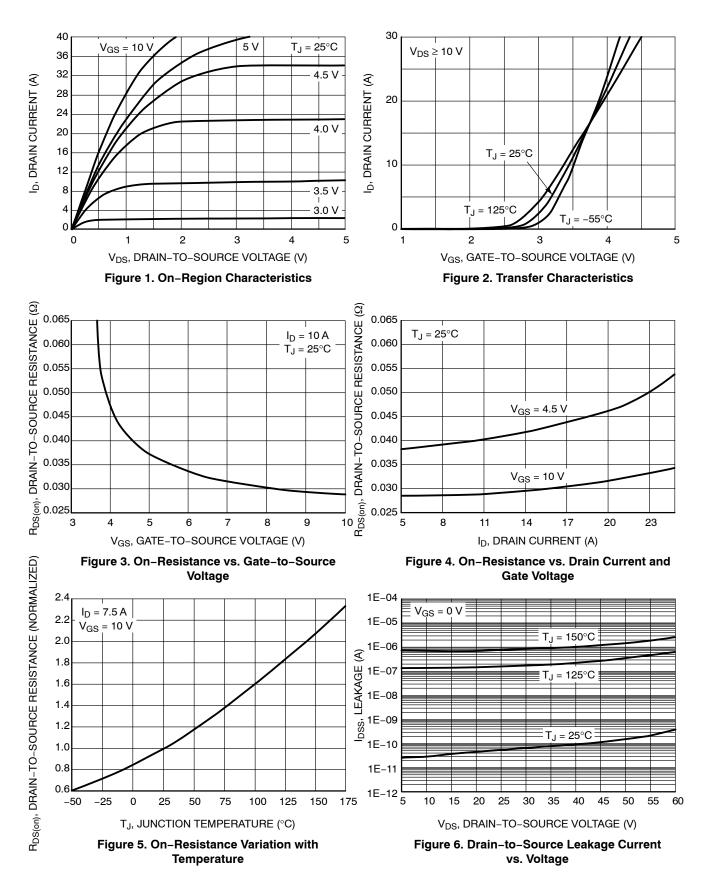
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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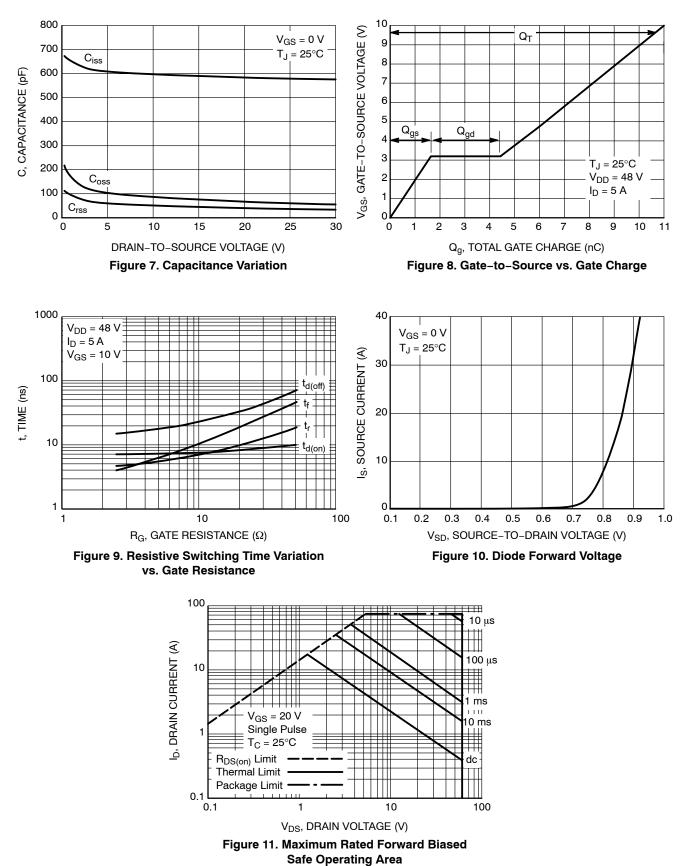
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		60		1	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				53		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$			1.0	μΑ
		V _{DS} = 60 V	$T_J = 125^{\circ}C$			10	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	s = ±20 V			±100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$			3.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				3.5		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 7.5 A		27	33	mΩ
		V _{GS} = 4.5 V	I _D = 7.5 A		37	45	
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _D = 5.0 A			7.0		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{iss}				540		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MI	Hz, V _{DS} = 25 V		55		1
Reverse Transfer Capacitance	C _{rss}				36		
Total Gate Charge	Q _{G(TOT)}				5.9		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _D	_S = 48 V,		0.62		
Gate-to-Source Charge	Q _{GS}	I _D = 5.0	A		1.64		
Gate-to-Drain Charge	Q _{GD}				2.80		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 4	18V, I _D = 5.0A		11	20	nC
SWITCHING CHARACTERISTICS (No	ote 6)						
Turn-On Delay Time	t _{d(on)}				8.1		ns
Rise Time	tr	V _{GS} = 4.5 V, V _D	_S = 48 V,		15.8		
Turn-Off Delay Time	t _{d(off)}	I _D = 5.0 A, R _G	= 2.5 Ω		11.8		1
Fall Time	t _f				3.9		
Turn-On Delay Time	t _{d(on)}				4.9		ns
Rise Time	t _r	V _{GS} = 10 V, V _D	_S = 48 V,		6.4		
Turn-Off Delay Time	t _{d(off)}	I _D = 5.0 A, R _G	= 2.5 Ω		14.5		
Fall Time	t _f				2.4		
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.8	1.2	V
		I _S = 5.0 A	$T_J = 125^{\circ}C$		0.7		
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V, } d_{IS}/d_t = 100 \text{ A}/\mu \text{s},$ $I_S = 5.0 \text{ A}$			14.5		ns
Charge Time	t _a				11.5		
Discharge Time	t _b				3.1		
Reverse Recovery Charge	Q _{RR}				11		nC
PACKAGE PARASITIC VALUES							
Source Inductance	Ls	T _A = 25°C			0.93		nH
Drain Inductance	L _D				0.005		
Gate Inductance	L _G				1.84		
Gate Resistance	R _G				1.5	[Ω

Pulse Test: pulse width = 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



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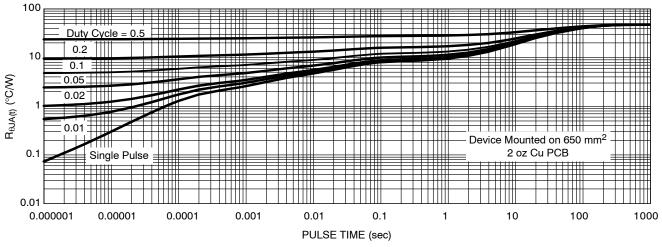
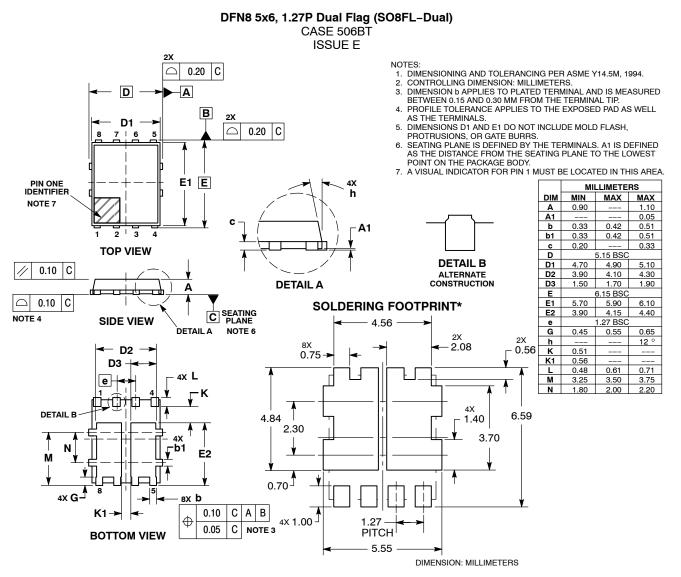


Figure 12. Thermal Response

PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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